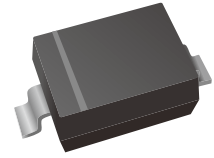


Transient Voltage Suppressors for ESD Protection

Features

- Transient protection for high-speed data lines
IEC 61000-4-2 (ESD) $\pm 30\text{kV}$ (Contact)
 $\pm 30\text{kV}$ (Air)
- Peak power dissipation: 1260W (8/20 μs)
- Working voltages : 4.5V
- Low leakage current
- Low clamping voltage
- Solid-state silicon-avalanche technology
- Lead free in comply with EU RoHS 2011/65/EU directives



Machanical Data

- Case: SOD-323
- Flammability Rating: UL 94V-0

Applications

- Power lines
- Personal digital assistants (PDA's)
- Microprocessors based equipment
- Notebooks, Desktops, and Servers
- Cell phone Handsets and Accessories
- Portable Electronics
- Peripherals

Ordering Information

Part Number	Marking	Shipping	Reel
LTES4V5A01HG-TR3	FS	3000PCS Tape&Reel	7 inchs
LTES4V5A01HG-TR12	FS	12000PCS Tape&Reel	13 inchs

Absolute Maximum Ratings (TA=25°C unless otherwise specified)

Symbol	Parameter	Value	Units
V _{ESD}	ESD per IEC 61000-4-2 (Contact)	±30	kV
	ESD per IEC 61000-4-2 (Air)	±30	
P _{PP}	Peak Pulse Power (8/20μs)	1260	W
I _{PP}	Peak Pulse Current (8/20μs)	90	A
T _{OPT}	Operating Temperature	-55~125	°C
T _{STG}	Storage Temperature	-55~150	°C
T _L	Lead Soldering Temperature	260(10sec)	°C

Electrical Characteristics (TA=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min	Typ	Max	Units
V _{RWM}	Reverse Working Voltage				4.5	V
V _{BR}	Reverse Breakdown Voltage	I _T = 1mA	5.0		7.0	V
I _R	Reverse Leakage Current	V _{RWM} = 4.5V			0.5	uA
V _C	Clamping Voltage	I _{PP} = 10A, t _p = 8/20μs			9	V
		I _{PP} = 90A, t _p = 8/20μs			14	V
C _J	Junction Capacitance	V _R = 0V, f = 1MHz			850	pF



Characteristics Curve

Fig.1 8/20us Waveform per IEC61000-4-5

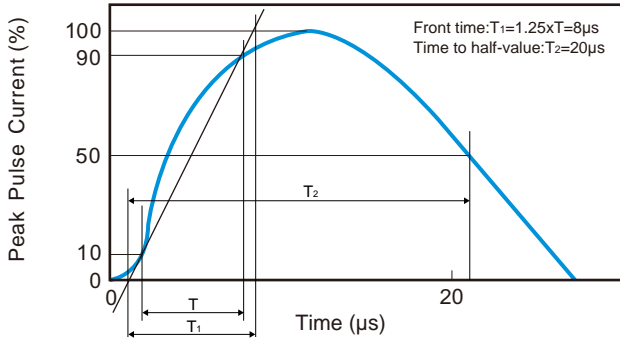


Fig.2 Contact Discharge Current Waveform per IEC 61000-4-2

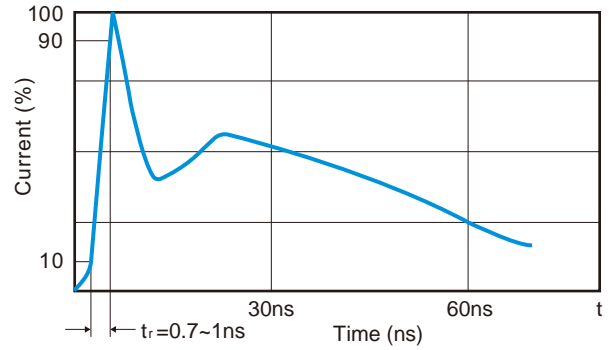


Fig.3 Power Derating Curve

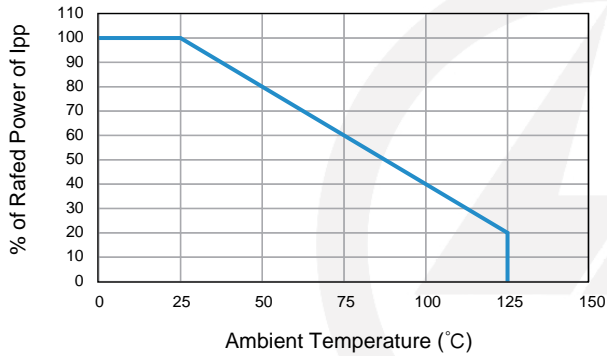
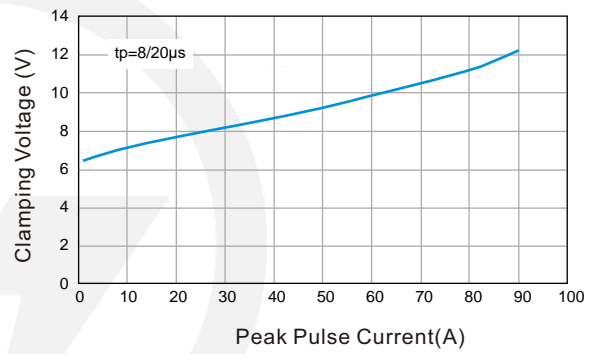


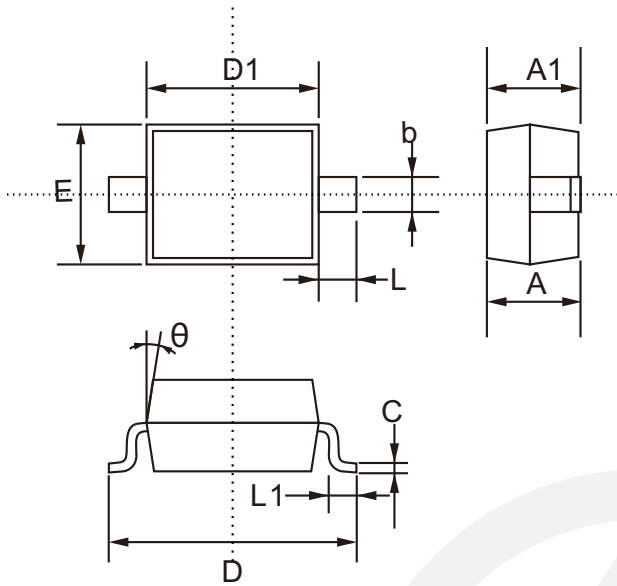
Fig.4 Clamping Voltage vs Peak Pulse Current





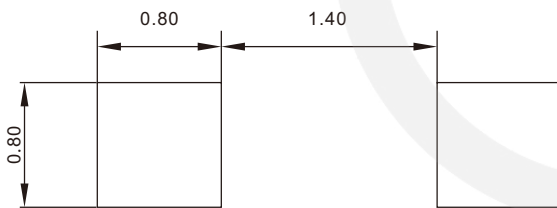
SOD-323 Package Outline

Unit: mm



SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.800	1.100
A1	0.800	0.900
b	0.250	0.400
C	0.080	0.177
D	2.300	2.800
D1	1.400	1.800
E	1.150	1.400
L1	0.100	0.400
L	0.475 TYP.	
θ	8°	

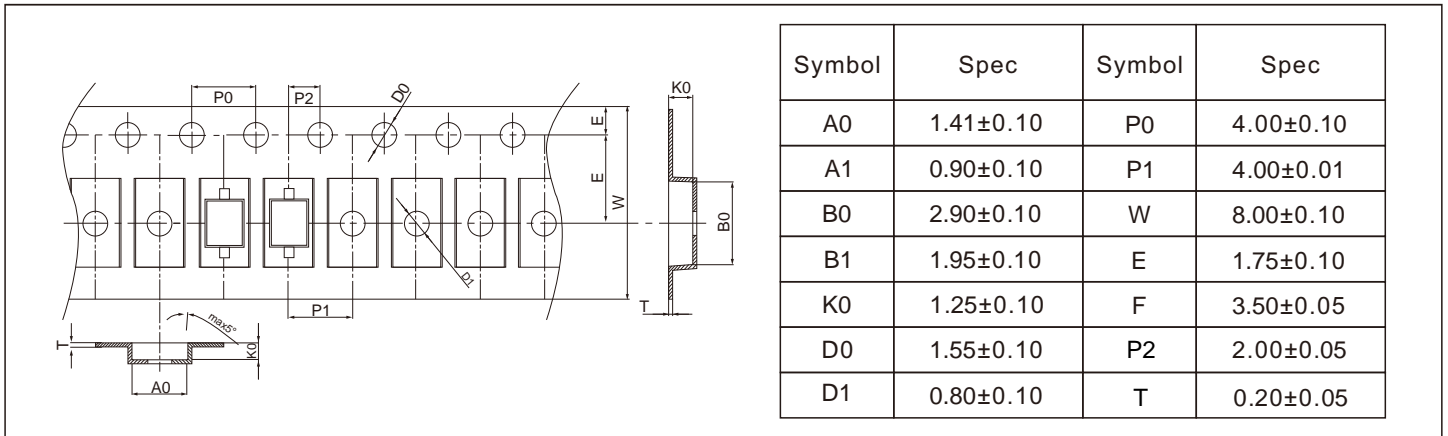
SOD-323 Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$
 3. The pad layout is for reference purpose only.

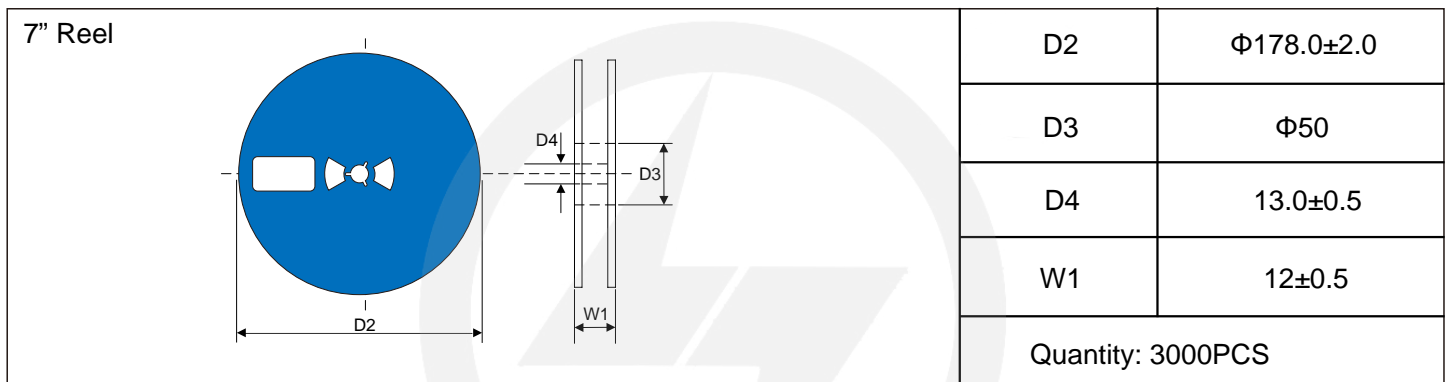
Carrier Tape Dimensions

Unit : mm



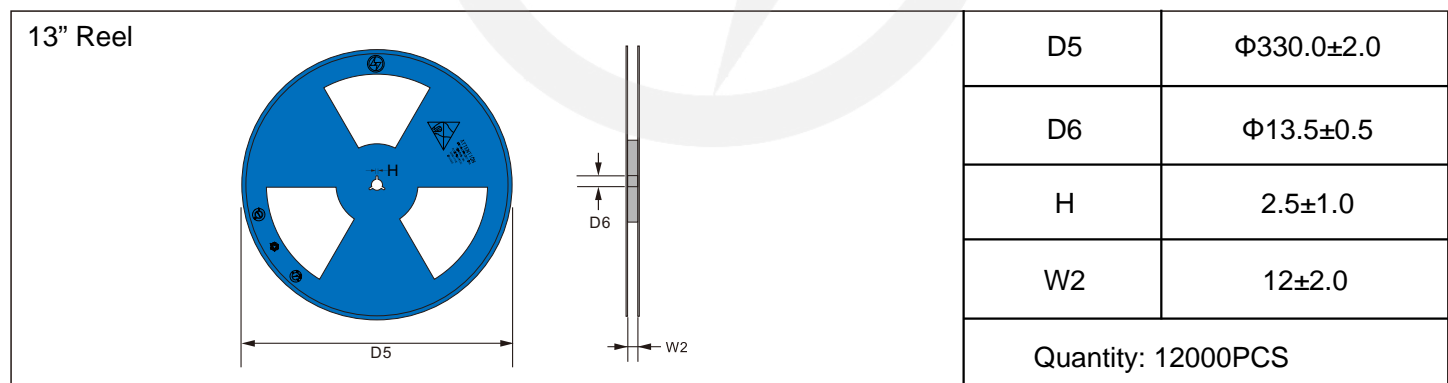
Reel Dimensions

Unit : mm

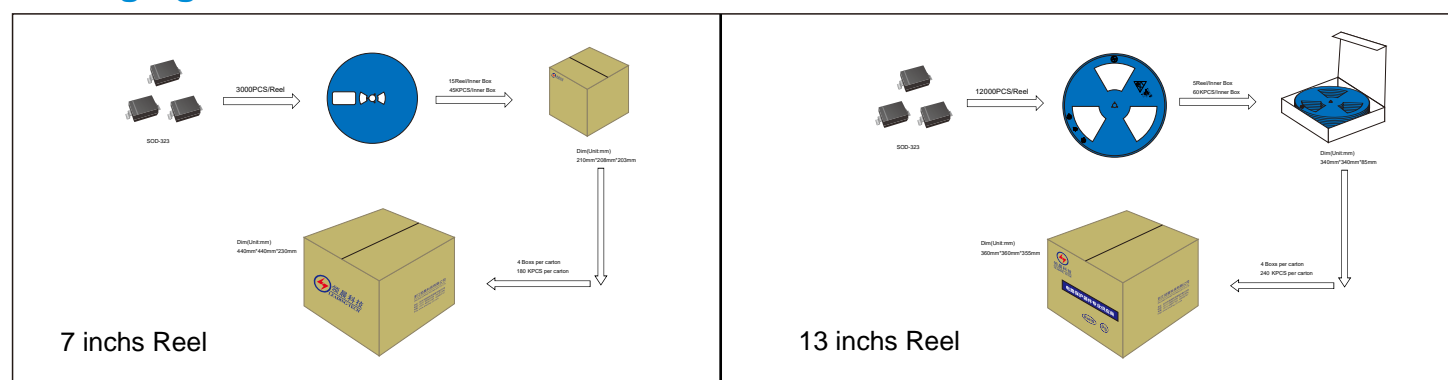


Reel Dimensions

Unit : mm



Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T _L to T _P)	3°C/second max.
Preheat	
-Temperature Min (T _{S min})	150°C
-Temperature Max (T _{S max})	200°C
-Time (min to max) (t _s)	60-180 seconds
T _{S max} to T _L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T _L)	217°C
-Time (t _L)	60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (t _p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2024.10.09	2024.10.09	3.0	New File	/	Ding	
02	2025.06.11	2025.06.11	3.1	Update packaging information	/	Ding	